

Improved, Quad, SPST Analog Switches

ABSOLUTE MAXIMUM RATINGS

(All Voltages Referenced to V-.)

V+	44V
GND	25V
V _L	(GND -0.3V) to (V+ +0.3V)
Digital Inputs, V _S , V _D (Note 1)	(V- -2V) to (V+ +2V) or 30mA (whichever occurs first)
Continuous Current (any terminal)	30mA
Peak Current (pulsed at 1ms, 10% duty cycle max)	100mA

Continuous Power Dissipation (T_A = +70°C)

16-Pin Plastic DIP (derate 10.53mW/°C above +70°C)	.842mW
16-Pin Narrow SO (derate 8.70mW/°C above +70°C)	...696mW
16-Pin CERDIP (derate 10.00mW/°C above +70°C)	800mW
16-Pin TSSOP (derate 6.7mW/°C above +70°C)	457mW
16-Pin QFN (derate 19.2mW/°C above +70°C)	1538mW

Operating Temperature Ranges

DG41_C	0°C to +70°C
DG41_D	-40°C to +85°C
DG41_AK	-55°C to +125°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Note 1: Signals on S, D, or IN exceeding V+ or V- are clamped by internal diodes. Limit forward current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = 15V, V- = -15V, V_L = 5V, V_{GND} = 0V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS			MIN		TYP (Note 2)	MAX	UNITS
SWITCH									
Analog Signal Range	V _{ANALOG}	(Note 3)			-15			15	V
Drain-Source On-Resistance	R _{DS(ON)}	V ₊ = 13.5V, V ₋ = -13.5V, V _D = ±8.5V, I _S = -10mA	T _A = +25°C	C, D	17			45	Ω
				A	17			30	
			T _A = T _{MIN} to T _{MAX}					45	
On-Resistance Match Between Channels (Note 4)	ΔR _{DS(ON)}	V ₊ = 15V, V ₋ = -15V, V _D = ±10V, I _S = -10mA	T _A = +25°C				3		Ω
			T _A = T _{MIN} to T _{MAX}				5		
On-Resistance Flatness (Note 4)	R _{FLAT(ON)}	V ₊ = 15V, V ₋ = -15V, V _D = ±5V, 0V, I _S = -10mA	T _A = +25°C				4		Ω
			T _A = T _{MIN} to T _{MAX}				6		
Source Off-Leakage Current (Note 7)	I _{S(OFF)}	V ₊ = 16.5V, V ₋ = -16.5V, V _D = ±15.5V, V _S = ±15.5V	T _A = +25°C	C, D, A	-0.25	-0.10	0.25		nA
			T _A = T _{MIN} to T _{MAX}	C, D	-5			5	
				A	-10			10	
Drain Off-Leakage Current (Note 7)	I _{D(OFF)}	V ₊ = 16.5V, V ₋ = -16.5V, V _D = ±15.5V, V _S = ±15.5V	T _A = +25°C	C, D, A	-0.25	-0.10	0.25		nA
			T _A = T _{MIN} to T _{MAX}	C, D	-5			5	
				A	-10			10	
Drain On-Leakage Current (Note 7)	I _{D(ON)} + I _{S(ON)}	V ₊ = 16.5V, V ₋ = -16.5V, V _D = ±15.5V, V _S = ±15.5V	T _A = +25°C	C, D, A	-0.4	-0.1	0.4		nA
			T _A = T _{MIN} to T _{MAX}	C, D	-20			20	
				A	-40			40	

Improved, Quad, SPST Analog Switches

DG411/DG412/DG413

ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

(V+ = 15V, V- = -15V, VL = 5V, VGND = 0V, VINH = 2.4V, VINL = 0.8V, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
INPUT							
Input Current with Input Voltage High	I _{INH}	IN = 2.4V, all others = 0.8V		-0.500	0.005	0.500	μA
Input Current with Input Voltage Low	I _{INL}	IN = 0.8V, all others = 2.4V		-0.500	0.005	0.500	μA
SUPPLY							
Power-Supply Range				±4.5		±20.0	V
Positive Supply Current	I+	All channels on or off, V+ = 16.5V, V- = -16.5V, V _{IN} = 0V or 5V	T _A = +25°C	-1	0.0001	1	μA
			T _A = T _{MIN} to T _{MAX}	-5		5	
Negative Supply Current	I-	All channels on or off, V+ = 16.5V, V- = -16.5V, V _{IN} = 0V or 5V	T _A = +25°C	-1	-0.0001	1	μA
			T _A = T _{MIN} to T _{MAX}	-5		5	
Logic Supply Current	I _L	All channels on or off, V+ = 16.5V, V- = -16.5V, V _{IN} = 0V or 5V	T _A = +25°C	-1	0.0001	1	μA
			T _A = T _{MIN} to T _{MAX}	-5		5	
Ground Current	I _{GND}	All channels on or off, V+ = 16.5V, V- = -16.5V, V _{IN} = 0V or 5V	T _A = +25°C	-1	-0.0001	1	μA
			T _A = T _{MIN} to T _{MAX}	-5		5	
DYNAMIC							
Turn-On Time	t _{ON}	V _D = ±10V, Figure 2	T _A = +25°C	110	175	ns	
			T _A = T _{MIN} to T _{MAX}		220		
Turn-Off Time	t _{OFF}	V _D = ±10V, Figure 2	T _A = +25°C	100	145	ns	
			T _A = T _{MIN} to T _{MAX}		160		
Break-Before-Make Time Delay	t _D	DG413 only, R _L = 300Ω, C _L = 35pF, Figure 3	T _A = +25°C	25		ns	
Charge Injection (Note 3)	Q	C _L = 1.0nF, V _{GEN} = 0V, R _{GEN} = 0Ω, Figure 4	T _A = +25°C	5	10	pC	
Off-Isolation (Note 5)	OIRR	R _L = 50Ω, C _L = 5pF, f = 1MHz, Figure 5	T _A = +25°C	68		dB	
Crosstalk (Note 6)		R _L = 50Ω, C _L = 5pF, f = 1MHz, Figure 6	T _A = +25°C	85		dB	
Source Off-Capacitance	C _{S(OFF)}	f = 1MHz, Figure 7	T _A = +25°C	9		pF	
Drain Off-Capacitance	C _{D(OFF)}	f = 1MHz, Figure 7	T _A = +25°C	9		pF	
Drain On-Capacitance	C _{D(ON)} + C _{S(ON)}	f = 1MHz, Figure 8	T _A = +25°C	35		pF	

Improved, Quad, SPST Analog Switches

ELECTRICAL CHARACTERISTICS—Single Supply

($V_+ = 12V$, $V_- = 0V$, $V_L = 5V$, $V_{GND} = 0V$, $V_{INH} = 2.4V$, $V_{INL} = 0.8V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP (Note 2)	MAX	UNITS
SWITCH							
Analog Signal Range	V _{ANALOG}	(Note 3)		0		12	V
Drain-Source On-Resistance	R _{DS(ON)}	V ₊ = 10.8V, V _D = 3.8V, I _S = -10mA	T _A = +25°C	40	80	Ω	
			T _A = T _{MIN} to T _{MAX}	100			
SUPPLY							
Positive Supply Current	I ₊	All channels on or off, V ₊ = 13.2V, V _{IN} = 0V or 5V	T _A = +25°C	-1	0.0001	1	μA
			T _A = T _{MAX}	-5	5		
Negative Supply Current	I ₋	All channels on or off, V ₊ = 13.2V, V _{IN} = 0V or 5V	T _A = +25°C	-1	0.0001	1	μA
			T _A = T _{MAX}	-5	5		
Logic Supply Current	I _L	All channels on or off, V _L = 5.25V, V _{IN} = 0V or 5V	T _A = +25°C	-1	0.0001	1	μA
			T _A = T _{MAX}	-5	5		
Ground Current	I _{GND}	All channels on or off, V _L = 5.25V, V _{IN} = 0V or 5V	T _A = +25°C	-1	-0.0001	1	μA
			T _A = T _{MAX}	-5	5		
DYNAMIC							
Turn-On Time	t _{ON}	V _S = 8V, Figure 2	T _A = +25°C	175	250	ns	
			T _A = T _{MIN} to T _{MAX}	315			
Turn-Off Time	t _{OFF}	V _S = 8V, Figure 2	T _A = +25°C	95	125	ns	
			T _A = T _{MIN} to T _{MAX}	140			
Break-Before-Make Time Delay	t _D	DG413 only, R _L = 300Ω, C _L = 35pF, Figure 3	T _A = +25°C	25		ns	
Charge Injection (Note 3)	Q	C _L = 1.0nF, V _{GEN} = 0V, R _{GEN} = 0V, Figure 4	T _A = +25°C	5	10	pC	

Note 2: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

Note 3: Guaranteed by design.

Note 4: $\Delta R_{ON} = \Delta R_{ON\ max} - \Delta R_{ON\ min}$. On-resistance match between channels and flatness are guaranteed only with bipolar-supply operation. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured at the extremes of the specified analog signal range.

Note 5: Off-Isolation = $20\log(V_D/V_S)$, V_D = output, V_S = input to off switch. See Figure 5.

Note 6: Between any two switches. See Figure 6.

Note 7: Leakage parameters $I_S(OFF)$, $I_D(OFF)$, and $I_D(ON)$ are 100% tested at the maximum-rated hot temperature and guaranteed by correlation at $+25^\circ C$.

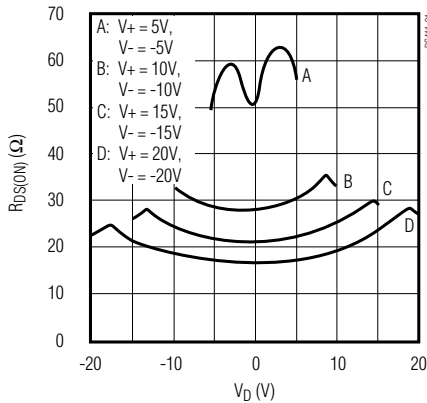
Improved, Quad, SPST Analog Switches

Typical Operating Characteristics

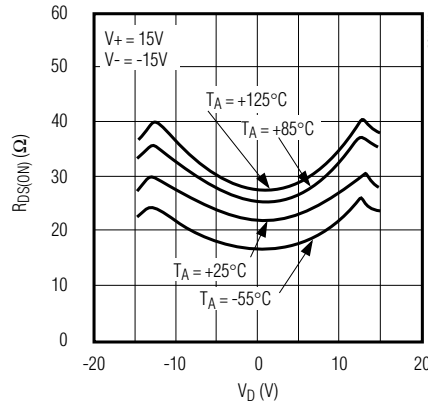
($T_A = +25^\circ\text{C}$, unless otherwise noted.)

DG411/DG412/DG413

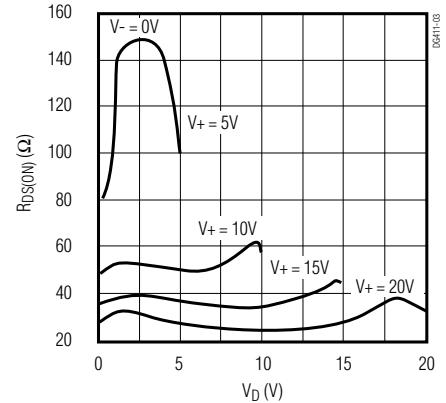
ON-RESISTANCE vs. V_D AND POWER-SUPPLY VOLTAGE



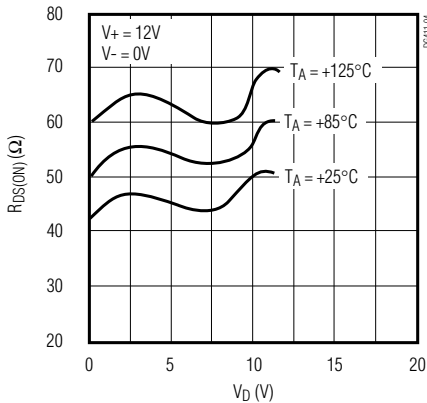
ON-RESISTANCE vs. V_D AND TEMPERATURE



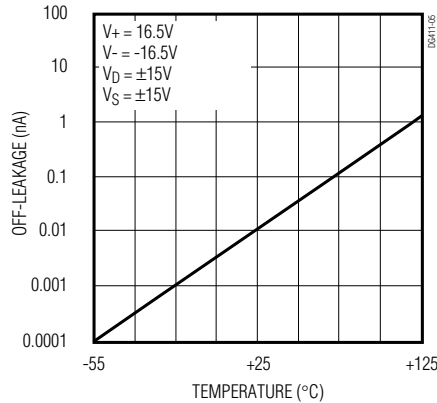
ON-RESISTANCE vs. V_D AND TEMPERATURE (SINGLE SUPPLY)



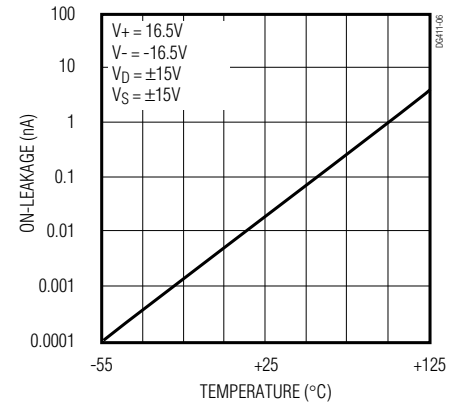
ON-RESISTANCE vs. V_D (SINGLE SUPPLY)



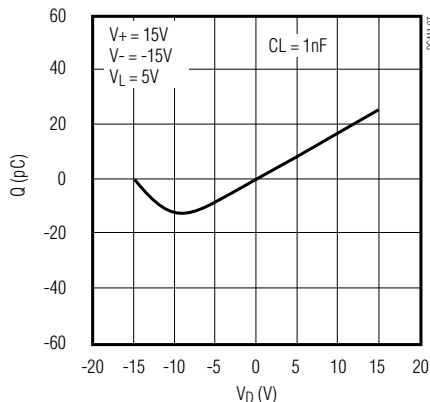
OFF-LEAKAGE CURRENTS vs. TEMPERATURE



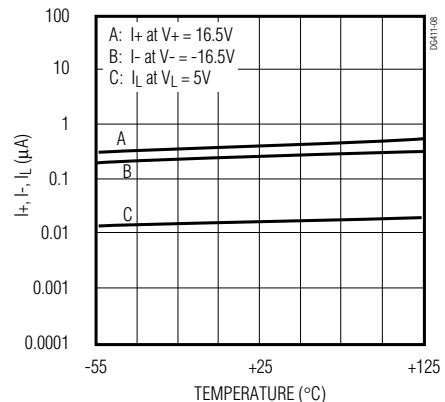
ON-LEAKAGE CURRENTS vs. TEMPERATURE



CHARGE INJECTION vs. ANALOG VOLTAGE



SUPPLY CURRENT vs. TEMPERATURE



Improved, Quad, SPST Analog Switches

Pin Description

PIN		NAME	FUNCTION
DIP/SO/TSSOP	QFN		
1, 16, 9, 8	15, 14, 7, 6	IN1–IN4	Input
2, 15, 10, 7	16, 13, 8, 5	D1–D4	Analog Switch Drain Terminal
3, 14, 11, 6	1, 12, 9, 4	S1–S4	Analog Switch Source Terminal
4	2	V-	Negative-Supply Voltage Input
5	3	GND	Ground
12	10	V _L	Logic Supply Voltage
13	11	V+	Positive-Supply Voltage Input—Connected to Substrate
—	—	EP	Exposed Paddle (QFN Only). Connect EP to V+.

Applications Information

Operation with Supply Voltages Other Than 15V

Using supply voltages other than 15V will reduce the analog signal range. The DG411/DG412/DG413 switches operate with $\pm 4.5\text{V}$ to $\pm 20\text{V}$ bipolar supplies or with a $+10\text{V}$ to $+30\text{V}$ single supply; connect V- to 0V when operating with a single supply. Also, all device types can operate with unbalanced supplies such as $+24\text{V}$ and -5V . V_L must be connected to $+5\text{V}$ to be TTL compatible, or to V+ for CMOS-logic level inputs. The *Typical Operating Characteristics* graphs show typical on-resistance with $\pm 15\text{V}$, $\pm 10\text{V}$, and $\pm 5\text{V}$ supplies. (Switching times increase by a factor of two or more for operation at $\pm 5\text{V}$.)

Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V+ on first, followed by V_L, V-, and logic inputs. If power-supply sequencing is not possible, add two small, external signal diodes in series with supply pins for overvoltage protection (Figure 1).

Adding diodes reduces the analog signal range to 1V below V+ and 1V below V-, without affecting low switch resistance and low leakage characteristics. Device operation is unchanged, and the difference between V+ and V- should not exceed $+44\text{V}$.

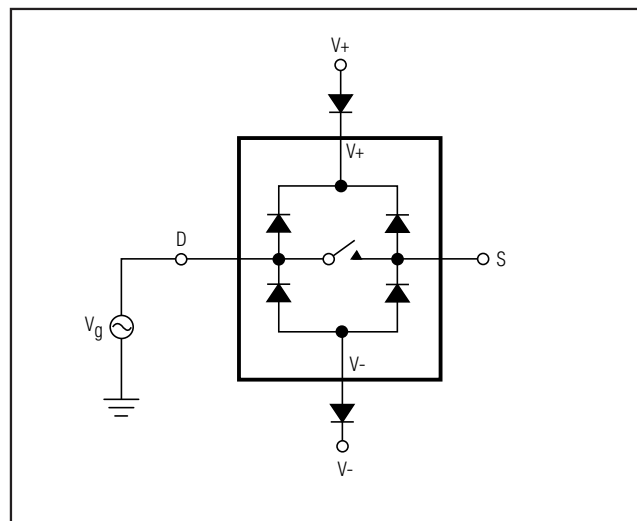


Figure 1. Overvoltage Protection Using External Blocking Diodes

Improved, Quad, SPST Analog Switches

Timing Diagrams/Test Circuits

DG411/DG412/DG413

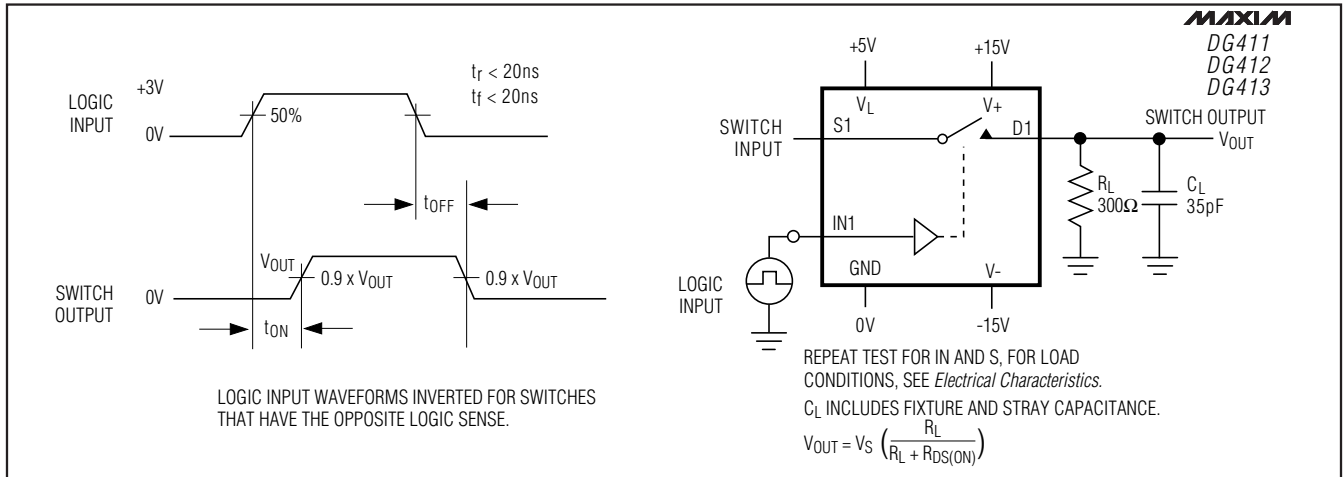


Figure 2. Switching-Time

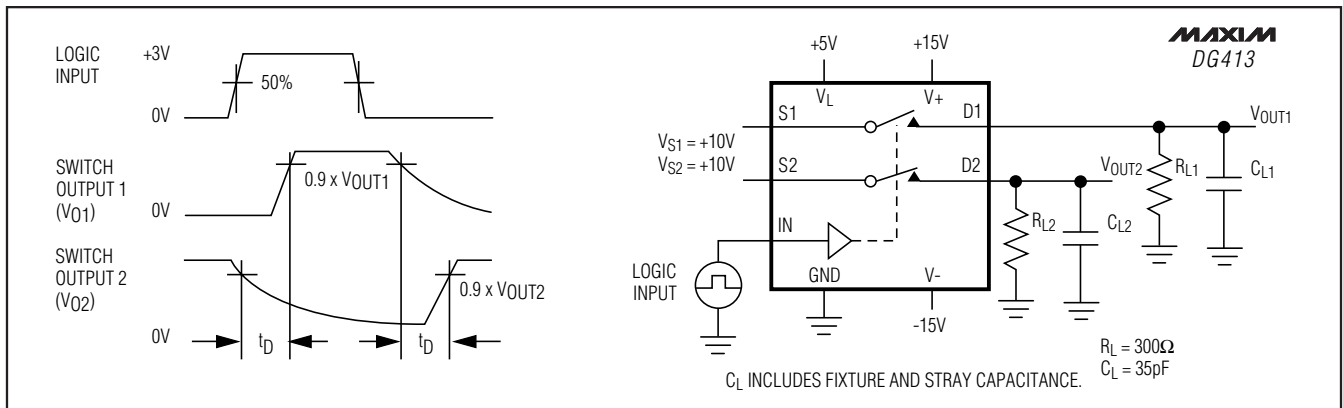


Figure 3. DG413 Break-Before-Make

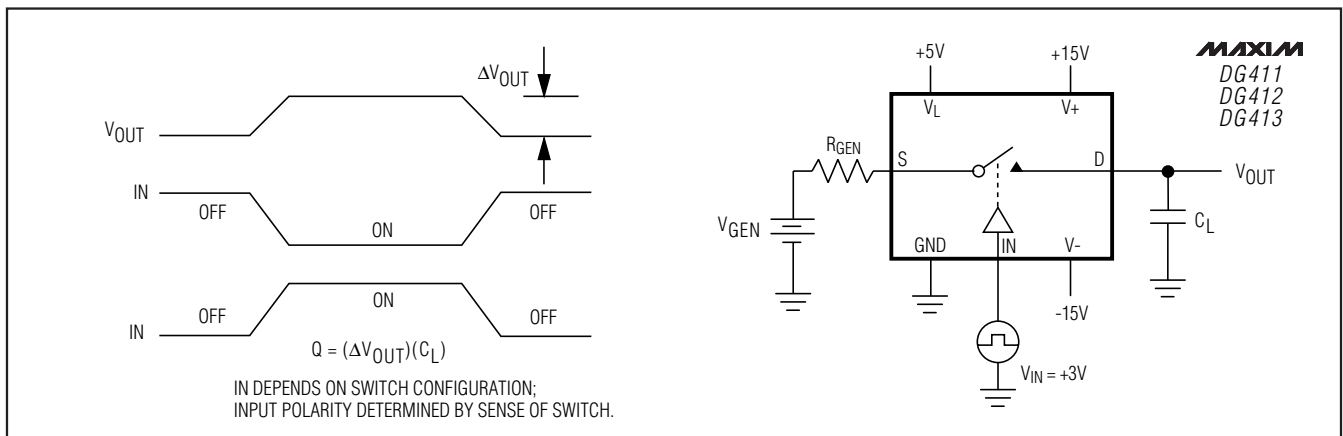


Figure 4. Charge-Injection

Improved, Quad, SPST Analog Switches

Timing Diagrams/Test Circuits (continued)

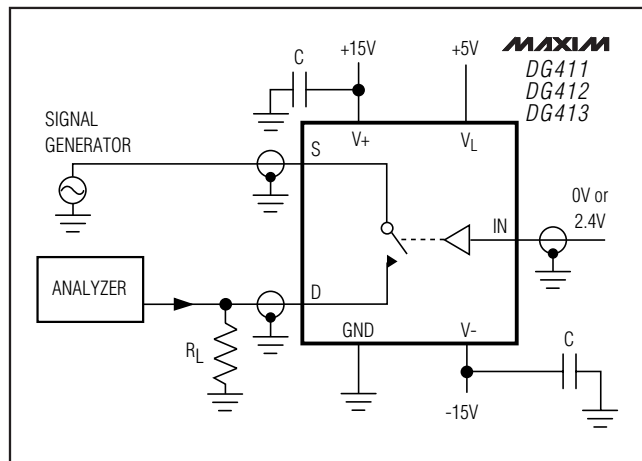


Figure 5. Off-Isolation

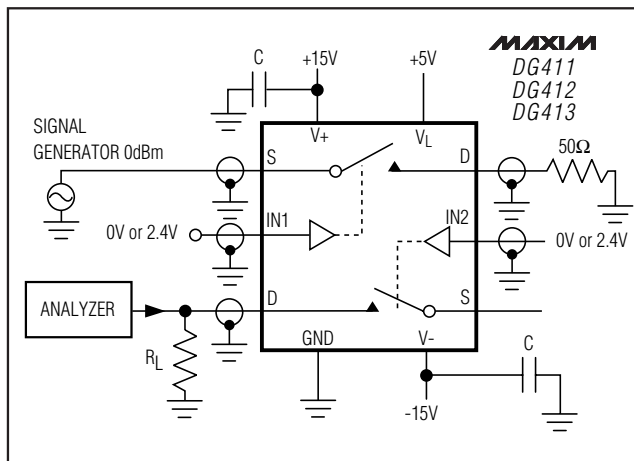


Figure 6. Crosstalk

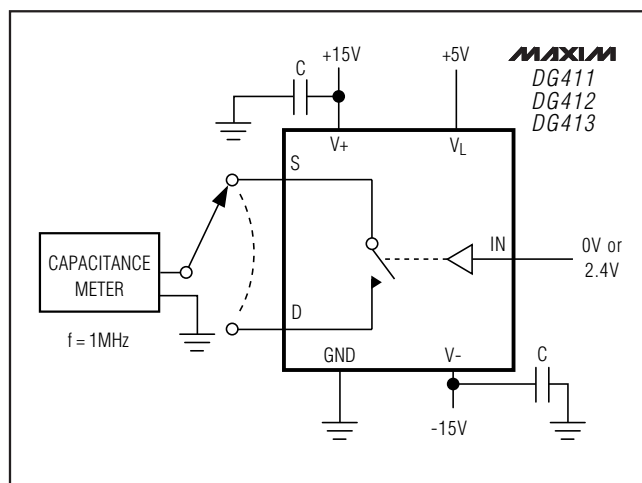


Figure 7. Channel Off-Capacitance

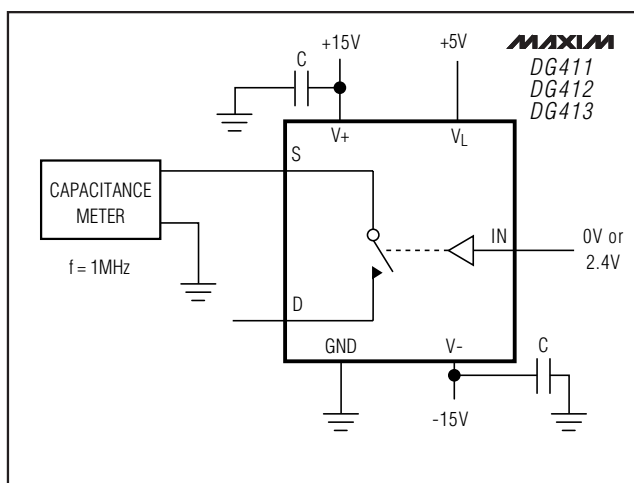


Figure 8. Channel On-Capacitance

Improved, Quad, SPST Analog Switches

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
DG411EGE	-40°C to +85°C	16 QFN-EP*
DG411DJ	-40°C to +85°C	16 Plastic DIP
DG411DY	-40°C to +85°C	16 Narrow SO
DG411DK	-40°C to +85°C	16 CERDIP
DG411AK	-55°C to +125°C	16 CERDIP**
DG411MY/PR	-55°C to +125°C	16 SO***
DG411MY/PR-T	-55°C to +125°C	16 SO***
DG412CJ	0°C to +70°C	16 Plastic DIP
DG412CUE	0°C to +70°C	16 TSSOP
DG412EUE	-40°C to +85°C	16 TSSOP
DG412CY	0°C to +70°C	16 Narrow SO
DG412C/D	0°C to +70°C	Dice†
DG412DJ	-40°C to +85°C	16 Plastic DIP
DG412EGE	-40°C to +85°C	16 QFN-EP*
DG412DY	-40°C to +85°C	16 Narrow SO
DG412DK	-40°C to +85°C	16 CERDIP
DG412AK	-55°C to +125°C	16 CERDIP**
DG412MY/PR	-55°C to +125°C	16 SO***
DG412MY/PR-T	-55°C to +125°C	16 SO***
DG413CJ	0°C to +70°C	16 Plastic DIP
DG413CUE	0°C to +70°C	16 TSSOP
DG413EUE	-40°C to +85°C	16 TSSOP
DG413CY	0°C to +70°C	16 Narrow SO
DG413C/D	0°C to +70°C	Dice†
DG413EGE	-40°C to +85°C	16 QFN-EP*
DG413DJ	-40°C to +85°C	16 Plastic DIP
DG413DY	-40°C to +85°C	16 Narrow SO
DG413DK	-40°C to +85°C	16 CERDIP
DG413AK	-55°C to +125°C	16 CERDIP**

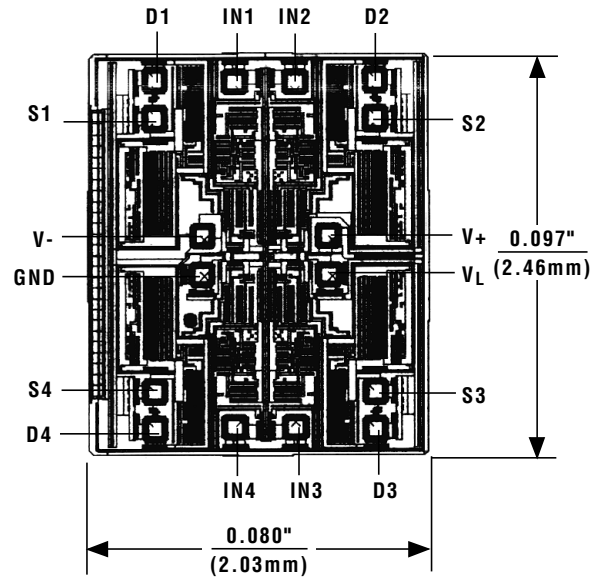
†Contact factory for dice specifications.

*EP = Exposed pad.

**Contact factory for availability and processing to MIL-STD-883B.

***Contact factory for availability.

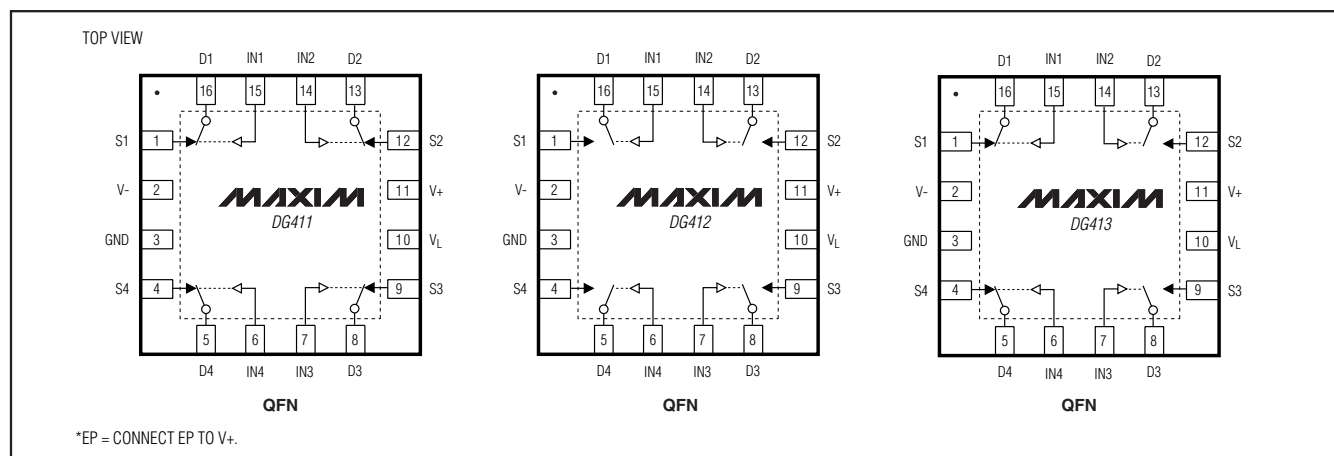
Chip Topography



DG411/DG412/DG413

Improved, Quad, SPST Analog Switches

Pin Configurations/Functional Diagrams (continued)



Improved, Quad, SPST Analog Switches

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
16 QFN-EP	G1655-3	21-0091
16 Plastic DIP	P16-1	21-0043
16 TSSOP	U16-2	21-0066
16 CERDIP	J16-3	21-0045
16 Narrow SO	S16-1	21-0041
16 SO	S16-1	21-0041

DG411/DG412/DG413

Improved, Quad, SPST Analog Switches

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
6	9/07	Addition of exposed pad information	1, 6, 9, 14, 15
7	9/08	Addition of rugged plastic information	1, 9

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

12 **Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600**

© 2008 Maxim Integrated Products

MAXIM is a registered trademark of Maxim Integrated Products, Inc.